NUMBER	GS-12-497	PRODUCT SPECIFICATION		FCj
TITLE	SD CAF	RD CONNECTOR	PAGE 1 of 8	REVISION G
			AUTHORIZED BY BIII Lin	12/26/09
			CLASSIFICATION UNRESTRIC	CTED

1.0 OBJECTIVE

This specification defines the performance test and quality requirements of SD card reader connector with push-push type.

2.0 SCOPE

This product specification is applied for SD card reader connector, which provides the interconnection between PCB to card.

3.0 GENERNAL REQUIREMENTS

3.1 **Drawing**: 10067847

3.2 Operation and Storage:

- 3.2.1 Current Rating: 0.5A.
- 3.2.2 Voltage Rating: 17V
- 3.2.3 Operating temperature : -40° C to 105° C
- 3.2.4 Storage temperature: -40° C to 105° C

3.3 Material:

- **3.3.1** Housing: LCP, GF30, UL94V-0, color: black.
- 3.3.2 SD Contact: Phosphor Bronze.
- 3.3.3 WP Contact: Copper Alloy.
- 3.3.4 CD Contact: Copper Alloy.
- 3.3.5 Shield: Stainless
- 3.3.6 Slider Cam: PA9T or LCP
- 3.3.7 Locking Arm: Stainless
- 3.3.8 Positioning Pin :Stainless
- 3.3.9 Spring: SWP-B

3.4 Finish:

3.4.1 SD/CD/WP Contact:(a) Contact area: Au plated (or equivalent palladium nickel)

 Copyright
 FCI

 Form E-3334
 GS-01-001

 Rev F
 GS-01-001

PDM: Rev:G STATUS: Released Printed: Nov 28, 2010

NUMBER	GS-12-497	PRODUCT SPECIFICATION		FCJ
TITLE	SD CAF	RD CONNECTOR	PAGE 2 of 8	REVISION G
			AUTHORIZED BY Bill Lin	12/26/09
			CLASSIFICATION UNRESTRICTED	

(b) Solder area: Mate Tin plated

(c) Under plated: Nickel plated overall.

3.4.2 Shield:(a) Solder area: Gold flash plated

(b) Under plated: Nickel plated overall

3.5 Commercial Standard Specification

3.5.1 EIA 364 Test methods for electrical connectors

3.5.2 UL-STD-94 Flammability

3.5.3 ASTM B422-90 High strength copper alloy

3.6 FCI Specifications:

3.6.1 BUS-15-002M Nickel Plating

3.6.2 BUS-15-005 Gold Plating

3.6.3 GES-31-002 Workmanship STD & Insp. Instruction

3.6.4 GS-14-1253 Package Specification

4.0 TEST REQUIREMENTS AND PROCEDURES

TEST DESCRIPTION	REQUIREMENTS	TEST METHOD & CONDITION
Examination of product	Meet requirements of product	Visual inspection
· ·	drawing	No physical damage
	ELECTRICAL REQUIREMENTS	
Contact Resistance	100mΩ Max.	20 mV maximum open circuit
		voltage
		EIA 364-06
Insulation Resistance	1000M Ω Min.	500V DC. 1 minute,
		EIA 364-21
Dielectric Withdrawing Voltage	No creeping discharge or	500V AC rms., 1 minute, test
Resistance	flashes occur	between adjacent contacts of
	Current leakage 1mA Max.	unmated sample
		EIA-364-20
	MECHANICAL REQUIREMENTS	6
Total ejection and insertion	Total ejection Force: 8N Min.	EIA 364-13
Force	Total Insertion Force: 12N Max.	speed:25 mm/minute
Vibration	No physical damage	Duration :3 axis, 8 hours per

Copyright FCI

Form E-3334 GS-01-001 Rev F

PDM: Rev:G STATUS: Released Printed: Nov 28, 2010

NUMBER	GS-12-497	PRODUCT SPECIFICATION		FCJ
TITLE	SD CAF	PAGE 3 of 8	REVISION G	
			AUTHORIZED BY Bill Lin	12/26/09
			CLASSIFICATION UNRESTRIC	CTED

Shock	Discontinuity:1u sec. max. No physical damage Discontinuity:1u sec. max.	spatial axis Frequency:10-1000 Hz – 0.35mm amplitude Acceleration :2G Sweep rate : 1 octave/min. Shock acceleration 50G Duration of individual shock=6 ms,
	·	half-wave sinusoidal No of shocks : 50 shocks per spatial axis
Contact Force	0.2N~0.4N.	
Wrestling (Flapping) Strength	No physical damage	Applied force 10N to SD card for Front direction. (The card should be inserted 15mm into the connector from the head of card)
Durability cycling	No physical damage. Push-push function must be workable.	Operation Cycles: 12,000 cycles, (500 cycles at -40°C; 10500
		cycles at 23°C; 1000 cycles at 85°C). Mated and unmated connector with cycles time about 45sec/cycle, see Figure 3.
	ENVIRONMENTAL REQUIREME	
Humidity heat cycles	No physical damage	Number of cycles: 6 Relative humidity: 90~100 % Cycle period: 24 hours See FIG 2.
Dust test	No physical damage	With SD CARD mated. Begin dust concentration of 300 g/cm*cm*cm of chamber volume, flow rate =300 m/s and exposure time of 1 hr.
High temperature operation	No physical damage	The test samples shall be soaked at 70c for 2 hours,unpowered
Low temperature operation	No physical damage	The test samples shall be soaked at -30c for 2 hours,unpowered
Salt Spray	No harmful corrosion	Temperature: 35°C±2°C Concentration: 5% Period: 48 hours EIA 364-26
Temperature shock test	No physical damage	Number of cycles: 100 Test cycle: Temp at start of test: room temp; Acclimatization period to 70c: <=10s

Copyright FCI

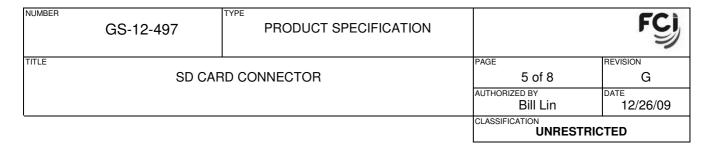
Form E-3334 GS-01-001

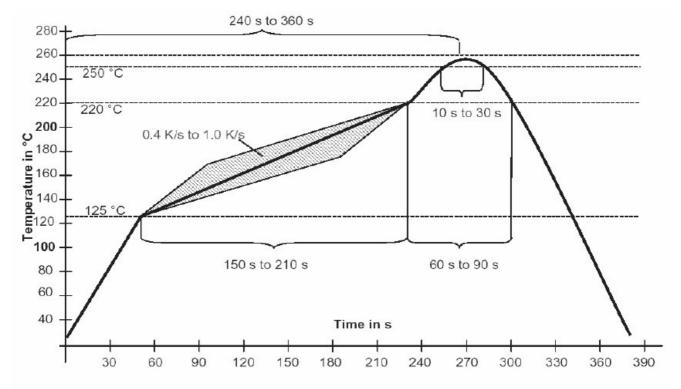
PDM: Rev:G STATUS:Released Printed: Nov 28, 2010

NUMBER	GS-12-497	PRODUCT SPECIFICATION		FC
TITLE	SD CAF	RD CONNECTOR	PAGE 4 of 8	REVISION G
			AUTHORIZED BY Bill Lin	DATE 12/26/09
`			CLASSIFICATION UNRESTRI	CTED

		Condition at 70c : 30 min Acclimatization period to -30c : <= 10s Condition at -30c : 45 min				
	PHYSICAL					
Solderability	The test area shall be covered more than 95% of immersed area with flash solder.	Solder temperature: 260 +0/-5°C Period: 10±0.5sec				
		Recommended reflow profile: Fig1 (Refer to J-STD-020).				

PDM: Rev:G STATUS:Released Printed: Nov 28, 2010





Preheat	125 °C to 220 °C 150 s to 210 s @ 0.4 K/s to 1.0 K/s
Time at T> 217 °C	60 s to 90 s
Peak temperature	260 °C -5/+0 °C
Peaktime	10 s to 30 s (≥ 250 °C)
Cooling rate	≤ 6 K/s
Time from 25 °C to peak	240 s to 360 s

Figure 1

Copyright FCI Form E-3334 Rev F

GS-01-001

NUMBER	GS-12-497	PRODUCT SPECIFICATION		F
TITLE	SD CAF	RD CONNECTOR	PAGE 6 of 8	REVISION G
			AUTHORIZED BY Bill Lin	DATE 12/26/09
			CLASSIFICATION UNRESTR	ICTED

Number of Cycles: 6+

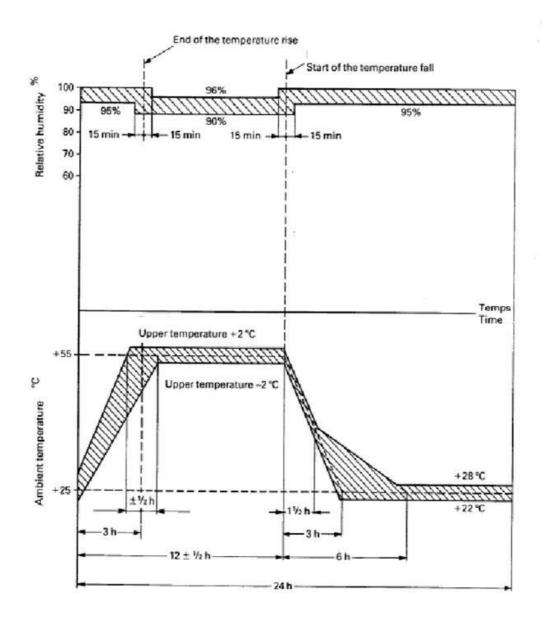


Figure 2

Copyright FCI Form E-3334 Rev F

GS-01-001

NUMBER	GS-12-497	PRODUCT SPECIFICATION		F
TITLE	SD CAF	RD CONNECTOR	PAGE 7 of 8	REVISION G
			AUTHORIZED BY Bill Lin	12/26/09
·			CLASSIFICATION UNRESTRIC	CTED

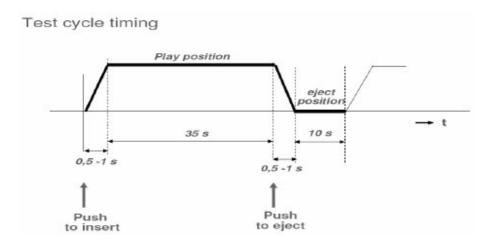


Figure 3

5.0 PRODUCT QUALIFICATION TEST SEQUENCE

	Test Group									
Test or Examination	A	В	C	D	E	F	G	Н		
					Te	st Sequ	uence (a)		
Examination of Product	1,10	1,6	1,7	1,5	1,5	1,9	1	1,3		
Contact Resistance	2,7	2,5	2,6	2,4	2,4	2,6				
Insulation Resistance	3,8					3,7				
Dielectric Withstanding Voltage	4,9					4,8				
Resistance	4,9					4,0				
Total Pulling and Insertion Force							3			
Vibration	5									
Physical Shock	6									
Contact Force							2			
Wrestling Strength				3						
Durability Cycling			3							
Humidity heat cycles(6 cycles)		3	5							
Salt Spray					3					
Solderability								2		
Temperature Shock test		4								
High/LowTemperature operation		-			_	5				
Dust test			4							

NOTE: Numbers indicated sequence in which tests are performed.

Copyright FCI Form E-3334 Rev F

GS-01-001

NUMBER	GS-12-497	PRODUCT SPECIFICATION		FC
TITLE	SD CAF	RD CONNECTOR	PAGE 8 of 8	REVISION G
			AUTHORIZED BY BIII Lin	12/26/09
			CLASSIFICATION UNRESTRI	CTED

REVISION RECORED

<u>REV</u>	<u>PAGE</u>	DESCRIPTION	<u>ECR</u>	DATE
Α	ALL	New Release	DG07-0495	12/21/2007
В	1	Change operating temperature (3.2.3)	DG08-0034	02/05/2008
С	1	PA9T has global supply shortage issue	DG08-0141	05/29/2008
D	1, 2	Change storage temperature range; Revise packing spec. No. mistake.	DG08-0185	07/23/2008
E	3, 6	Change durability cycling test method and condition.	DG09-0258	08/10/2009
F	4, 5	Revise reflow profile mistake	DG09-0387	12/14/2009
G	ALL	Change confidential form to unrestricted form	DG09-0403	12/26/2009

PDM: Rev:G STATUS:Released Printed: Nov 28, 2010

AMEYA360 Components Supply Platform

Authorized Distribution Brand:

























Website:

Welcome to visit www.ameya360.com

Contact Us:

> Address:

401 Building No.5, JiuGe Business Center, Lane 2301, Yishan Rd Minhang District, Shanghai , China

> Sales:

Direct +86 (21) 6401-6692

Email amall@ameya360.com

QQ 800077892

Skype ameyasales1 ameyasales2

Customer Service :

Email service@ameya360.com

Partnership :

Tel +86 (21) 64016692-8333

Email mkt@ameya360.com